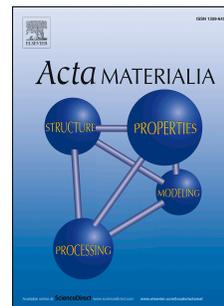


# Accepted Manuscript

Microstructural evolution and deformation behavior of Al-Cu alloys: A transmission X-ray microscopy (TXM) and micropillar compression study

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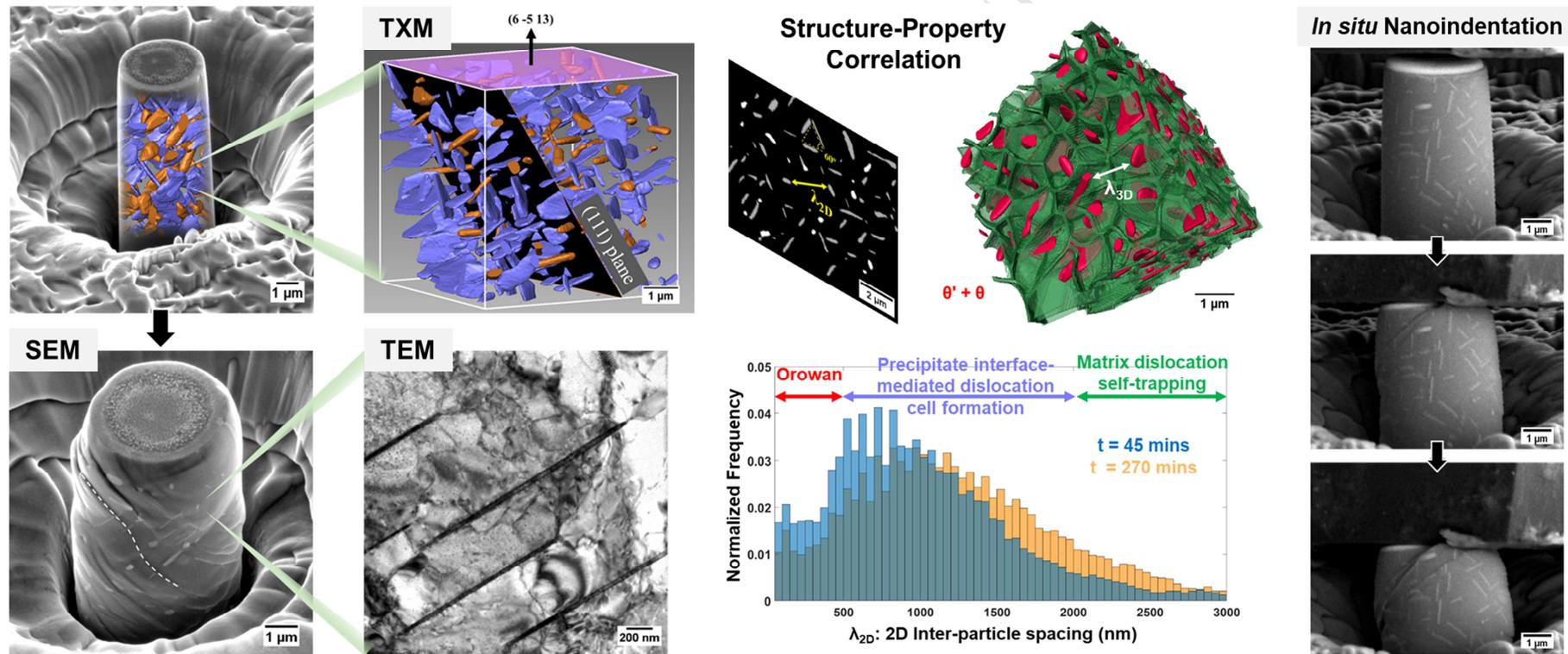
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